

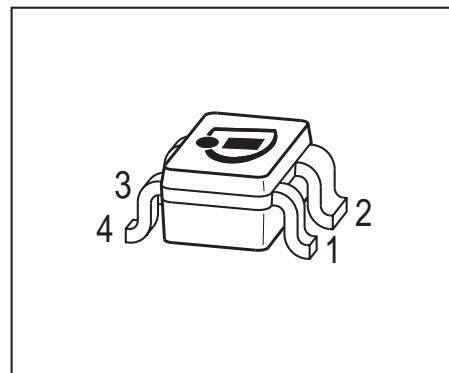
## NPN Silicon RF Transistor

- For highest gain low noise amplifier at 1.8 GHz and 2 mA / 2 V

**Outstanding G<sub>ms</sub> = 23.5 dB**

**Noise Figure F = 0.95 dB**

- For oscillators up to 15 GHz
- Transition frequency  $f_T = 45$  GHz
- Gold metallisation for high reliability
- SIEGET ® 45 - Line**
- Pb-free (RoHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101



**ESD (Electrostatic discharge) sensitive device, observe handling precaution!**

Type	Marking	Pin Configuration						Package
BFP520	APs	1=B	2=E	3=C	4=E	-	-	SOT343

## Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage $T_A > 0$ °C	$V_{CEO}$	2.5	V
$T_A \leq 0$ °C		2.4	
Collector-emitter voltage	$V_{CES}$	10	
Collector-base voltage	$V_{CBO}$	10	
Emitter-base voltage	$V_{EBO}$	1	
Collector current	$I_C$	40	mA
Base current	$I_B$	4	
Total power dissipation <sup>2)</sup> $T_S \leq 105$ °C	$P_{tot}$	100	mW
Junction temperature	$T_j$	150	°C
Ambient temperature	$T_A$	-65 ... 150	
Storage temperature	$T_{stg}$	-65 ... 150	

<sup>1</sup>Pb-containing package may be available upon special request

<sup>2</sup> $T_S$  is measured on the collector lead at the soldering point to pcb

**Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	$R_{thJS}$	$\leq 450$	K/W

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**DC Characteristics**

Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	2.5	3	3.5	V
Collector-emitter cutoff current $V_{CE} = 10 \text{ V}, V_{BE} = 0$	$I_{CES}$	-	-	10	$\mu\text{A}$
Collector-base cutoff current $V_{CB} = 5 \text{ V}, I_E = 0$	$I_{CBO}$	-	-	200	nA
Emitter-base cutoff current $V_{EB} = 1 \text{ V}, I_C = 0$	$I_{EBO}$	-	-	35	$\mu\text{A}$
DC current gain $I_C = 20 \text{ mA}, V_{CE} = 2 \text{ V}, \text{pulse measured}$	$h_{FE}$	70	110	170	-

<sup>1)</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

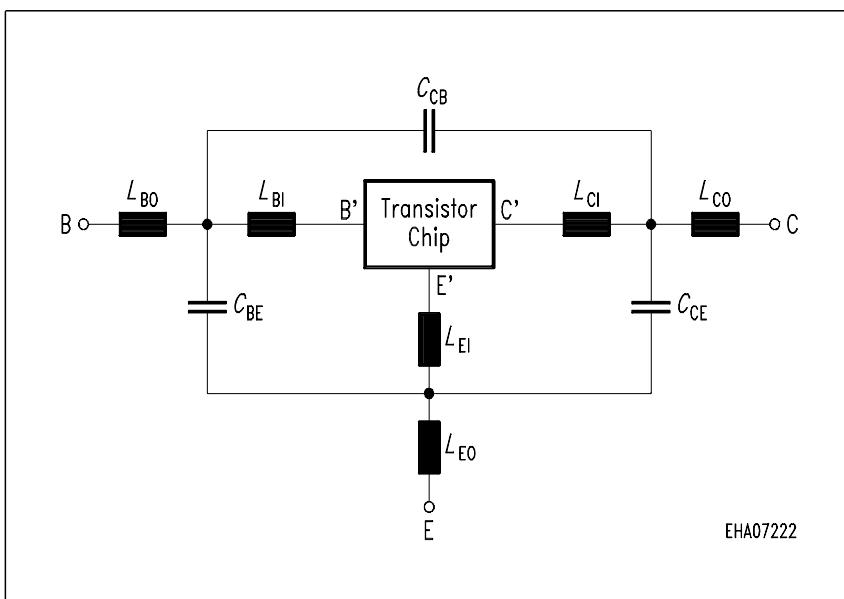
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>AC Characteristics</b> (verified by random sampling)					
Transition frequency $I_C = 30 \text{ mA}, V_{CE} = 2 \text{ V}, f = 2 \text{ GHz}$	$f_T$	32	45	-	GHz
Collector-base capacitance $V_{CB} = 2 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0 \text{ , emitter grounded}$	$C_{cb}$	-	0.06	0.13	pF
Collector emitter capacitance $V_{CE} = 2 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0 \text{ , base grounded}$	$C_{ce}$	-	0.3	-	
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{CB} = 0 \text{ , collector grounded}$	$C_{eb}$	-	0.35	-	
Noise figure $I_C = 2 \text{ mA}, V_{CE} = 2 \text{ V}, Z_S = Z_{\text{Sopt}}, f = 1.8 \text{ GHz}$	$F$	-	0.95	-	dB
Power gain, maximum stable <sup>1)</sup> $I_C = 20 \text{ mA}, V_{CE} = 2 \text{ V}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}, f = 1.8 \text{ GHz}$	$G_{ms}$	-	23.5	-	dB
Insertion power gain $V_{CE} = 2 \text{ V}, I_C = 20 \text{ mA}, f = 1.8 \text{ GHz}, Z_S = Z_L = 50 \Omega$	$ S_{21} ^2$	-	21	-	
Third order intercept point at output $V_{CE} = 2 \text{ V}, I_C = 20 \text{ mA}, f = 1.8 \text{ GHz}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}$ $V_{CE} = 2 \text{ V}, I_C = 7 \text{ mA}, f = 1.8 \text{ GHz}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}$	$IP_3$	-	25	-	dBm
1dB Compression point $I_C = 20 \text{ mA}, V_{CE} = 2 \text{ V}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}, f = 1.8 \text{ GHz}$ $I_C = 7 \text{ mA}, V_{CE} = 2 \text{ V}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}, f = 1.8 \text{ GHz}$	$P_{-1\text{dB}}$	-	12	-	
<sup>1)</sup> $G_{ms} =  S_{21} / S_{12} $					

<sup>1)</sup> $G_{ms} = |S_{21} / S_{12}|$

**SPICE Parameter (Gummel-Poon Model, Berkley-SPICE 2G.6 Syntax):**
**Transistor Chip Data:**

IS =	15	aA	BF =	235	-	NF =	1	-
VAF =	25	V	IKF =	0.4	A	ISE =	25	fA
NE =	2	-	BR =	1.5	-	NR =	1	-
VAR =	2	V	IKR =	0.01	A	ISC =	20	fA
NC =	2	-	RB =	11	$\Omega$	IRB =	-	A
RBM =	7.5	$\Omega$	RE =	0.6	-	RC =	7.6	$\Omega$
CJE =	235	fF	VJE =	0.958	V	MJE =	0.335	-
TF =	1.7	ps	XTF =	10	-	VTF =	5	V
ITF =	0.7	A	PTF =	50	deg	CJC =	93	fF
VJC =	0.661	V	MJC =	0.236	-	XCJC =	1	-
TR =	50	ns	CJS =	0	fF	VJS =	0.75	V
MJS =	0.333	-	XTB =	-0.25	-	EG =	1.11	eV
XTI =	0.35	-	FC =	0.5		TNOM	298	K

All parameters are ready to use, no scaling is necessary. Extracted on behalf of Infineon Technologies AG by:  
Institut für Mobil- und Satellitentechnik (IMST)

**Package Equivalent Circuit:**


$L_{BI}$ =	0.47	nH
$L_{BO}$ =	0.53	nH
$L_{EI}$ =	0.23	nH
$L_{EO}$ =	0.05	nH
$L_{CI}$ =	0.56	nH
$L_{CO}$ =	0.58	nH
$C_{BE}$ =	136	fF
$C_{CB}$ =	6.9	fF
$C_{CE}$ =	134	fF

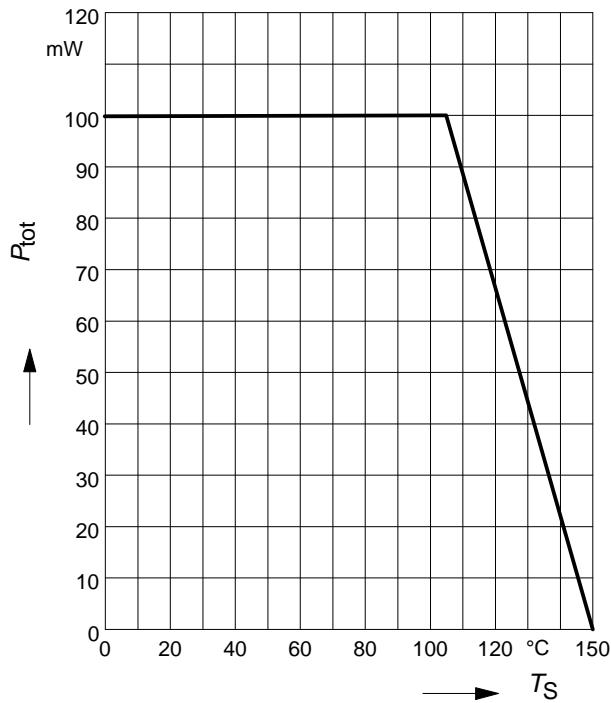
Valid up to 6GHz

EHA07222

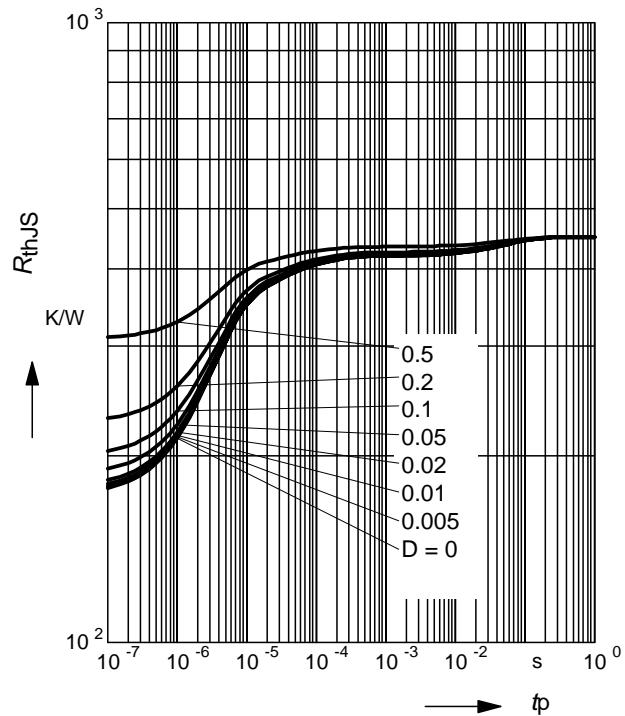
The SOT343 package has two emitter leads. To avoid high complexity to the package equivalent circuit both leads are combined in one electrical connection

For examples and ready to use parameters please contact your local Infineon Technologies distributor or sales office to obtain a InfineonTechnologies CD-ROM or see Internet: <http://www.infineon.com/silicondiscretes>

**Total power dissipation**  $P_{\text{tot}} = f(T_S)$

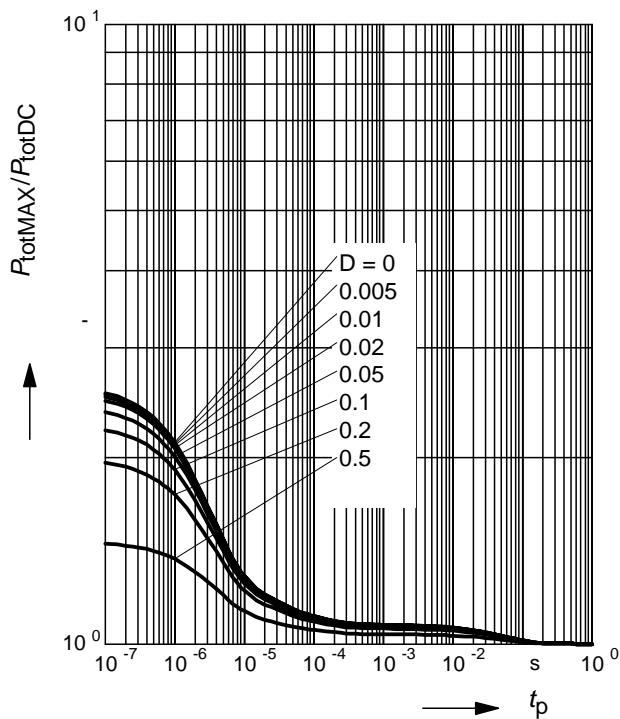


**Permissible Pulse Load**  $R_{\text{thJS}} = f(t_p)$



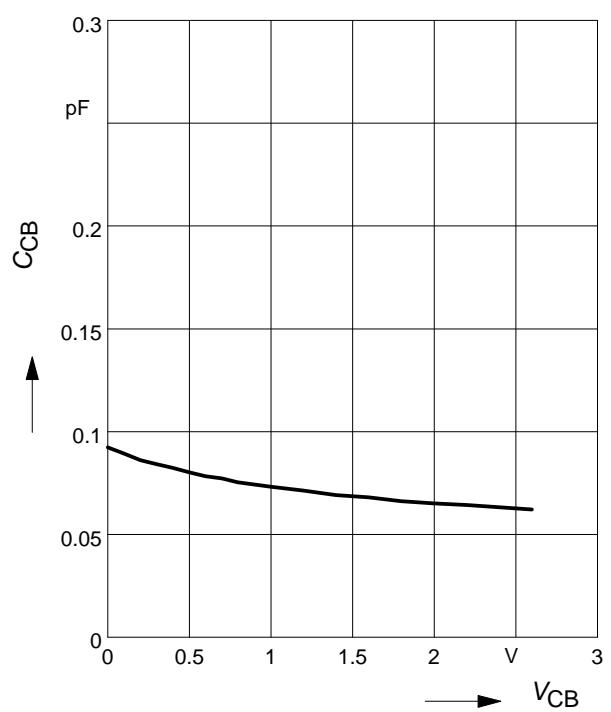
**Permissible Pulse Load**

$$P_{\text{totMAX}}/P_{\text{totDC}} = f(t_p)$$



**Collector-base capacitance**  $C_{\text{cb}} = f(V_{\text{CB}})$

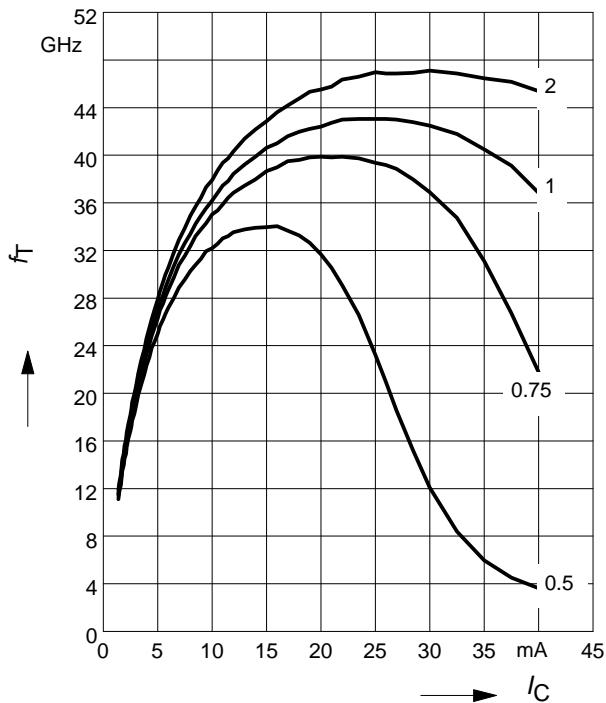
$f = 1\text{MHz}$



**Transition frequency  $f_T = f(I_C)$**

$f = 2 \text{ GHz}$

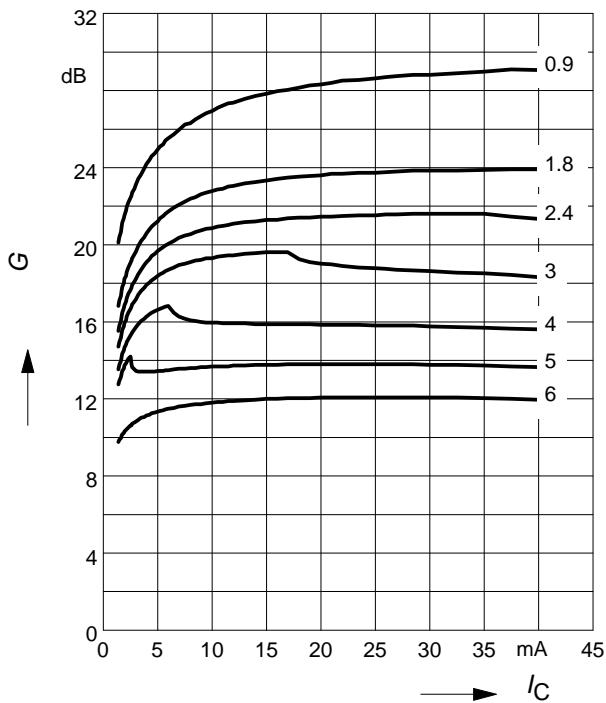
$V_{CE} = \text{parameter in V}$



**Power gain  $G_{ma}, G_{ms} = f(I_C)$**

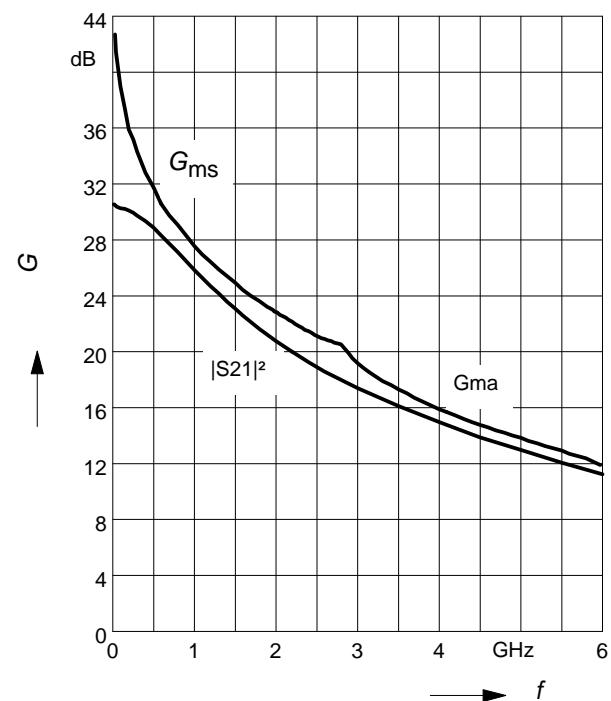
$V_{CE} = 2\text{V}$

$f = \text{parameter in GHz}$



**Power gain  $G_{ma}, G_{ms}, |S_{21}|^2 = f(f)$**

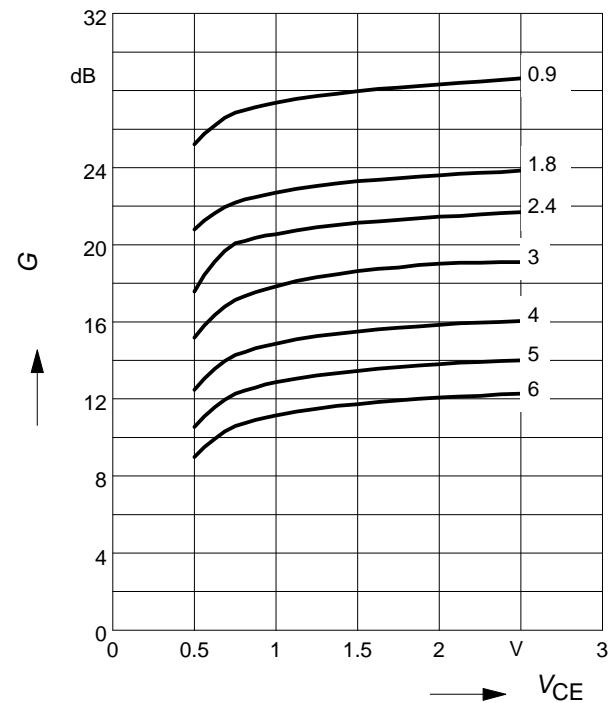
$V_{CE} = 2 \text{ V}, I_C = 20 \text{ mA}$

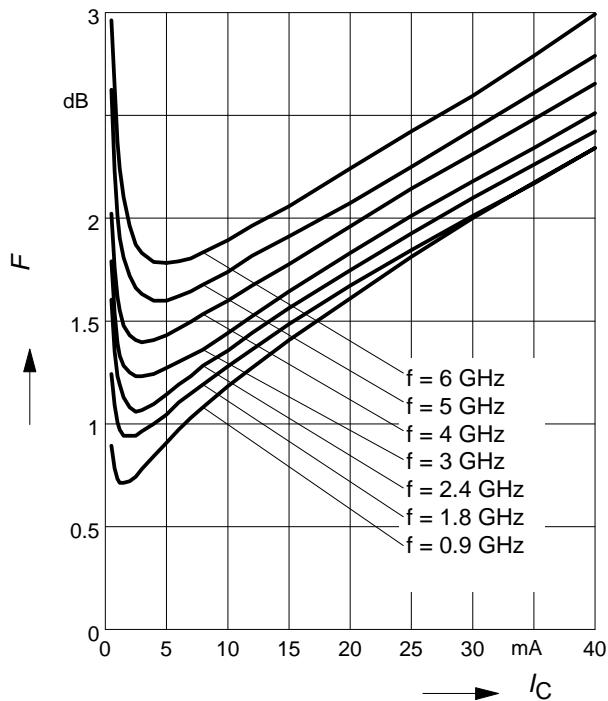
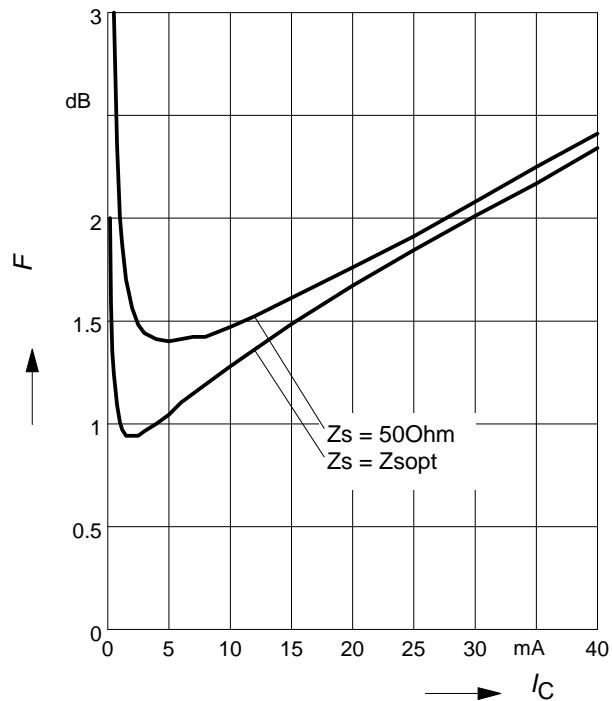
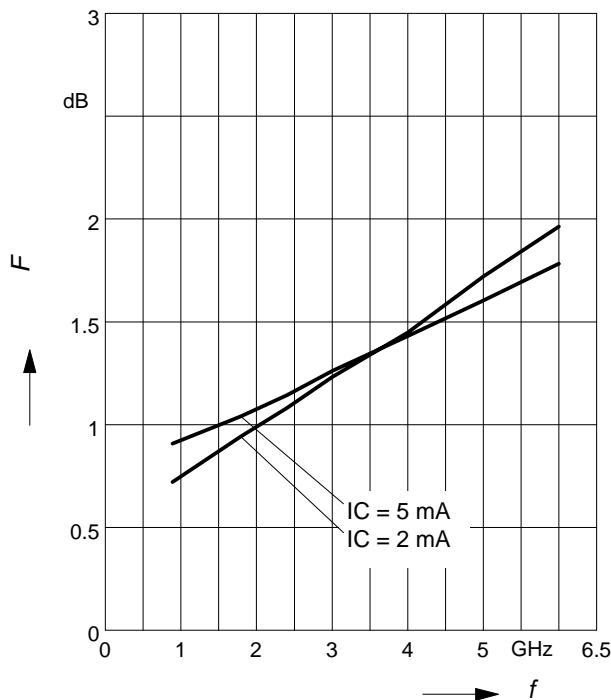
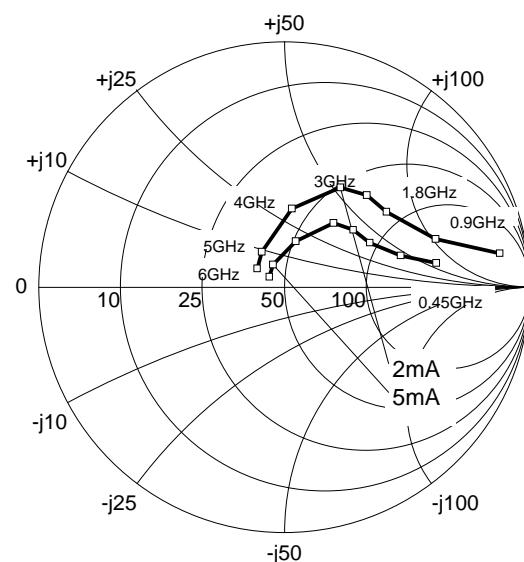


**Power gain  $G_{ma}, G_{ms} = f(V_{CE})$**

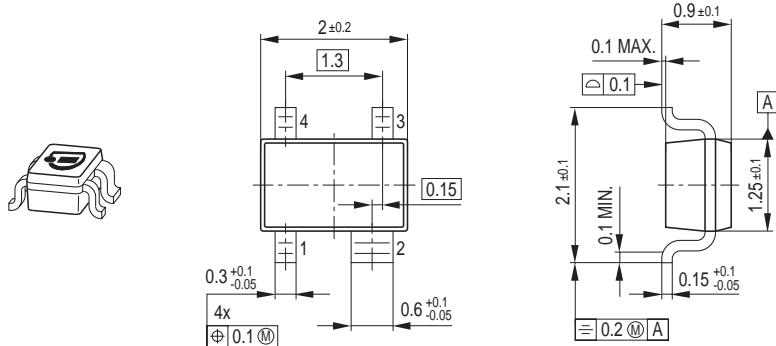
$I_C = 20 \text{ mA}$

$f = \text{parameter in GHz}$

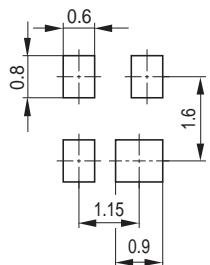


**Noise figure  $F = f(I_C)$** 
 $V_{CE} = 2 \text{ V}$ ,  $Z_S = Z_{\text{Sopt}}$ 

**Noise figure  $F = f(I_C)$** 
 $V_{CE} = 2 \text{ V}$ ,  $f = 1.8 \text{ GHz}$ 

**Noise figure  $F = f(f)$** 
 $V_{CE} = 2 \text{ V}$ ,  $Z_S = Z_{\text{Sopt}}$ 

**Source impedance for min.**
**noise figure vs. frequency**
 $V_{CE} = 2 \text{ V}$ ,  $I_C = 2 \text{ mA} / 5 \text{ mA}$ 


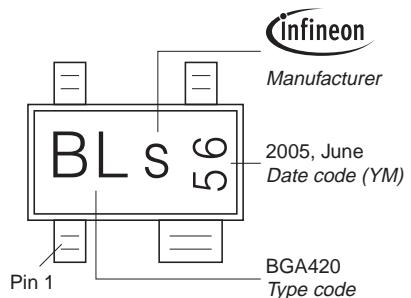
### Package Outline



### Foot Print

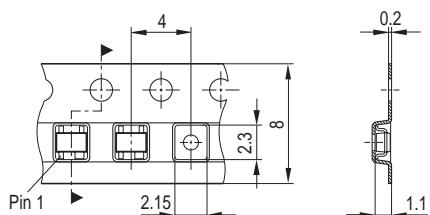


### Marking Layout (Example)



### Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel  
Reel ø330 mm = 10.000 Pieces/Reel



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